# **MOSFET** – N-Channel, SUPREMOS

**600 V, 25 A, 126 m**Ω

# FCH25N60N

## Description

The SUPREMOS<sup>®</sup> MOSFET is ON Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SUPREMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.

### Features

- $R_{DS(on)} = 108 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 12.5 \text{ A}$
- Ultra Low Gate Charge (Typ.  $Q_g = 57 \text{ nC}$ )
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 262 pF)
- 100% Avalanche Tested
- This Device is Pb-Free and is RoHS Compliant

#### Applications

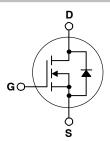
- Solar Inverter
- AC–DC Power Supply



# **ON Semiconductor®**

#### www.onsemi.com

V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
600 V	126 mΩ @ 10 V	25 A

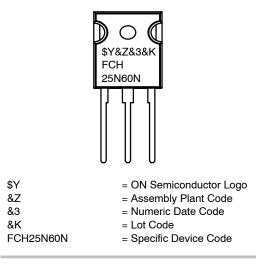


N-CHANNEL MOSFET



TO-247-3LD CASE 340CK

#### MARKING DIAGRAM



## ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter		Value	Unit
V <sub>DSS</sub>	Drain to Source Voltage		600	V
V <sub>GSS</sub>	Gate to Source Voltage		±30	V
Ι <sub>D</sub>	Drain Current	– Continuous (T <sub>C</sub> = 25°C)	25	А
		– Continuous (T <sub>C</sub> = 100°C)	16	1
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	75	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		861	mJ
I <sub>AR</sub>	Avalanche Current (Note 1)		8.3	А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		2.2	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	1
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)	216	W
		– Derate above 25°C	1.72	W/∘C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		–55 to + 150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Second		300	°C

## **ABSOLUTE MAXIMUM RATINGS** (T<sub>C</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2.  $I_{AS} = 8.3 \text{ A}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25 \text{ °C}$ 3.  $I_{SD} \leq 25 \text{ A}$ , di/dt  $\leq 200 \text{ A/s}$ ,  $V_{DD} \leq 380 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ 

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size Tape Width Quan		Quantity
FCH25N60N	FCH25N60N	TO-247-3LD	Tube	N/A	N/A	30 Units

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Value	Unit
$R_{ ext{ heta}JC}$	R <sub>0JC</sub> Thermal Resistance, Junction to Case, Max.		°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

## ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
FF CHARA	ACTERISTICS					-
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D$ = 1 mA, $V_{GS}$ = 0 V, $T_J$ = 25°C	600	-	-	V
$\begin{array}{c} \Delta \text{BV}_{\text{DSS}} \\ /  \Delta \text{T}_{\text{J}} \end{array}$	Breakdown Voltage Temperature Coefficient	$I_D = 1 \text{ mA}$ , Referenced to 25°C	-	0.74	_	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ = 480 V, $V_{GS}$ = 0 V	-	-	10	μΑ
		$V_{DS}$ = 480 V, $T_{J}$ = 125°C	-	-	100	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = $\pm 30$ V, $V_{DS}$ = 0 V	-	-	±100	nA
ON CHARA	CTERISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}=V_{DS},\ I_{D}=250\ \mu A$	2.0	-	4.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.5 A	-	0.108	0.126	Ω
OYNAMIC C	HARACTERISTICS					-
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz	-	2520	3352	pF
C <sub>oss</sub>	Output Capacitance		-	103	137	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	3.2	5	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ = 380 V, $V_{GS}$ = 0 V, f = 1 MHz	-	55	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V	-	262	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 12.5 \text{ A},$	-	57	74	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	V <sub>GS</sub> = 10 V (Note 4)	-	10	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	18	-	nC
ESR	Equivalent Series Resistance(G-S)	f = 1 MHz	-	1	-	Ω
WITCHING	CHARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 12.5 \text{ A},$	-	21	52	ns
tr	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$ (Note 4)	-	22	54	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	68	146	ns
t <sub>f</sub>	Turn-Off Fall Time		_	5	20	ns
RAIN-SOU	RCE DIODE CHARACTERISTICS					
۱ <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	25	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	75	А
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS}$ = 0 V, I <sub>SD</sub> = 12.5 A	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 12.5 A,$	-	370	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 A/μs	_	7	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

Q<sub>rr</sub>

### **TYPICAL CHARACTERISTICS**

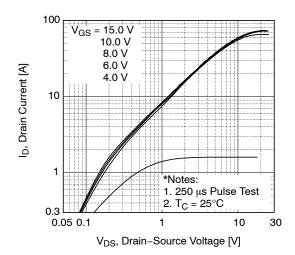


Figure 1. On–Region Characteristics

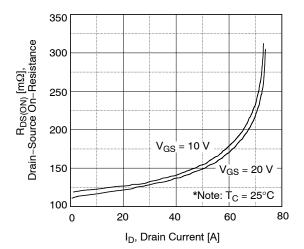
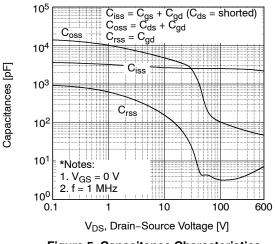


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage





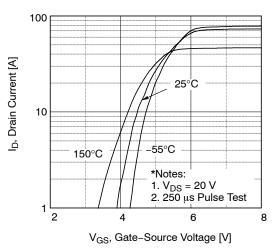


Figure 2. Transfer Characteristics

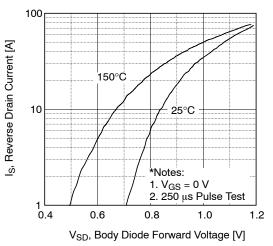
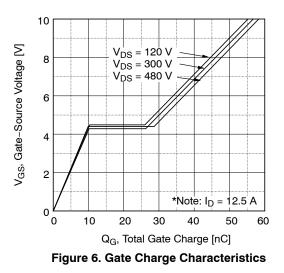
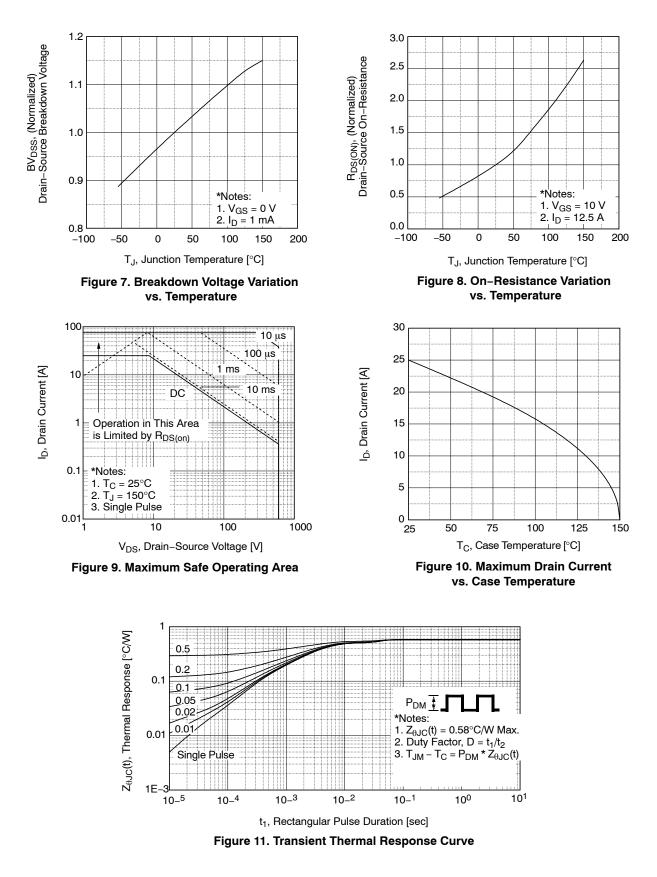
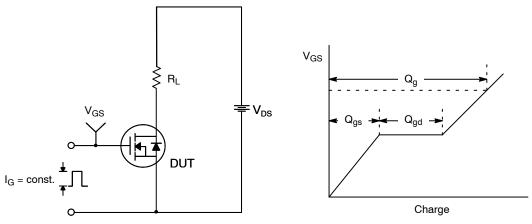


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



## **TYPICAL CHARACTERISTICS**







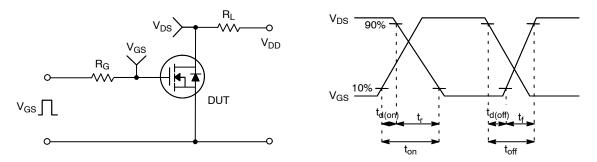
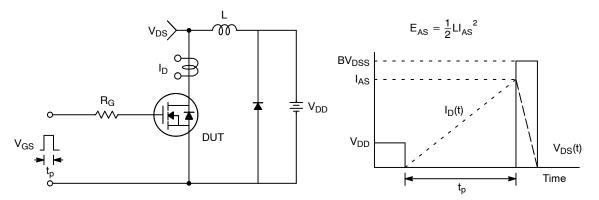


Figure 13. Resistive Switching Test Circuit & Waveforms





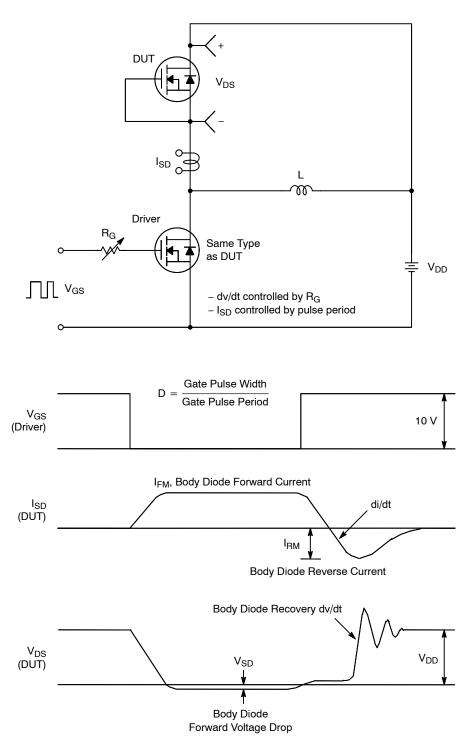


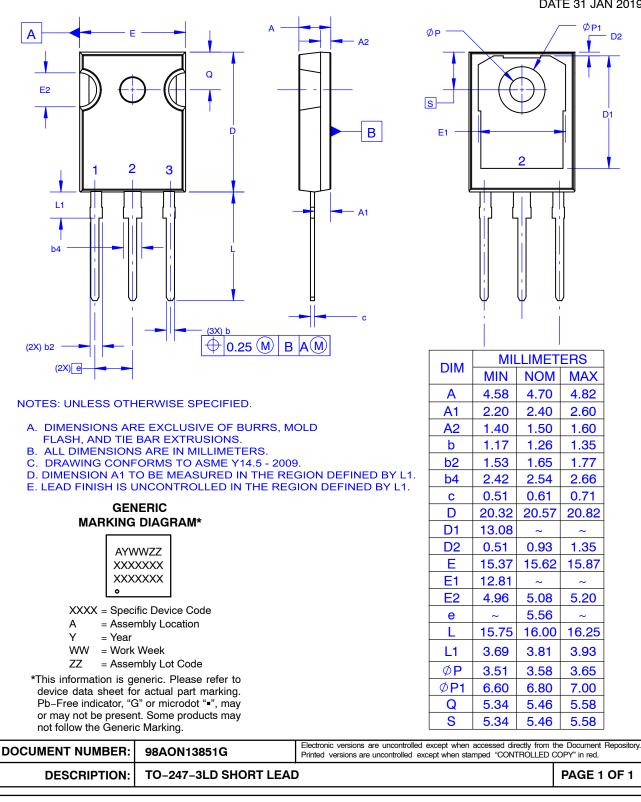
Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TO-247-3LD SHORT LEAD CASE 340CK **ISSUE A** 

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